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- (71) Applicant (for all designated States except US): **EMERSON ELECTRIC CO.** [US/US]; 8000 West Florissant, St. Louis, Missouri 63136 (US).
- (72) Inventors; and
- (75) Inventors/Applicants (for US only): **VANDENEYNDEN, Brian** [US/US]; c/o Fusite Corporation-Emerson, 6000 Fernview Avenue, Cincinnati, Ohio 45212 (US). **KHADKIKAR, Prasad S.** [US/US]; c/o Fusite Corporation-Emerson, 6000 Fernview Avenue, Cincinnati, Ohio 45212 (US). **SCHUCKMANN, Scott** [US/US]; c/o Fusite Corporation-Emerson, 6000 Fernview Avenue, Cincinnati, Ohio 45212 (US). **SUN, Jian** [CN/US]; c/o Fusite Corporation-Emerson, 6000 Fernview Avenue, Cincinnati, Ohio 45212 (US). **LAKNER, Gabriel** [US/US]; c/o Fusite Corporation-Emerson, 6000 Fernview Avenue, Cincinnati, Ohio 45212 (US).
- (74) Agents: **UTYKANSKI, David P.** et al.; Harness, Dickey & Pierce, P.L.C., P.O. Box 828, Bloomfield Hills, Michigan 48303 (US).
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Declarations under Rule 4.17:

- as to applicant's entitlement to apply for and be granted a patent (Rule 4.17(ii))

[Continued on next page]

(54) Title: SOLID CORE GLASS BEAD SEAL WITH STIFFENING RIB

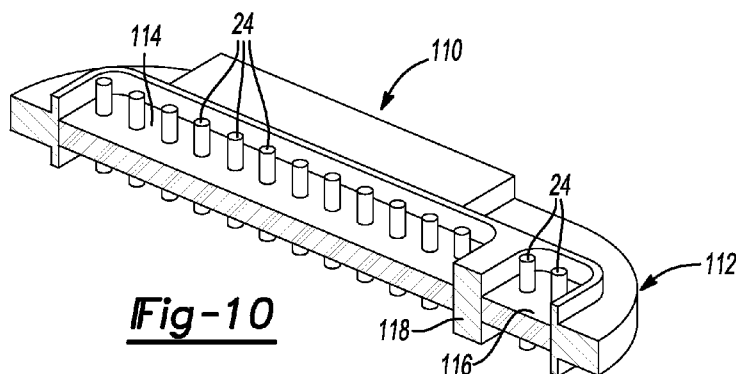


Fig-10

(57) Abstract: A hermetic feed-through includes a housing body defining a hollow space, a plurality of conductive pins and a seal structure. The plurality of conductive pins extend through the hollow space. The seal structure is provided in the hollow space and includes a single-piece glass component. The single-piece glass component hermetically seals at least two conductive pins to the housing body and electrically insulates the at least two conductive pins from the housing body.



- *as to the applicant's entitlement to claim the priority of the earlier application (Rule 4.17(iii))* — *before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments (Rule 48.2(h))*

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